Department of Electronics and Communication Engineering Maharaja Agrasen Institute of Technology

Guidelines for Preparation of Final Internship Report (ES-456)

The guidelines prescribed in here are intended to be followed by B.Tech (ECE) students of MAIT for preparing their preparing final **Internship Report** (**ES-456**). The report should contain the following items in the sequence as prescribed:

- Cover Page
- Declaration (as per the format attached)
- Certificate from the Company (as per the format attached)
- Certificate from the Institute (as per the format attached)
- Acknowledgement
 - Sections of the acknowledgement should express gratitude to the faculty supervisor(s), Company Supervisor (if any), Institute, Principal, HOD and TnP Coordinator(s).
 - Gratitude towards the mentor, peers, family members, friends, etc. may also be added if you wish to include.
- Abstract (1 page only)
- Table of Contents (Drawing of Table is strictly prohibited)
- List of Figures (Drawing of Table is strictly prohibited)
- List of Tables (Drawing of Table is strictly prohibited)
- Chapters (as per format attached)
- Bibliography
- Appendix

General Format Guidelines:

- Paper size: A4 (Single Side Printing)
- Margins: Left- 1.5", Right- 1.0", Top- 1.0", Bottom- 1.0" (Normal Setting)
- Chapters Name: Bold- 16 points, Font- Times New Roman, Left Aligned
- Main Heading: Bold- 14 points, Font- Times New Roman, Left Aligned
- Sub Headings: Italics- 12 points, Font- Times New Roman, Left Aligned
- Main Body: Normal- 12 points, Font- Times New Roman, Justified
- Line spacing: 1.5
- Footer: Normal- 10 Points, Times New Roman- Left Aligned (NAME OF THE DEPARTMENT) Footer should not be present on Cover Page
- Page Numbers in Footer: Normal-10 Points, Times New Roman- Right Aligned, Roman Page number till Table of Contents. No Page number should be marked on the Cover page. The page numbers should be in numerals from Starting from Chapter 1.
- Figure Numbers: Normal- 10 points, Font- Times New Roman, Centre Aligned, Below the figure (Figure itself should be center aligned too). Figure must be cited if required.
- Table Numbers: Normal- 10 points, Font- Times New Roman, Centre Aligned, Above the table (Table itself should be center aligned too). Table must be cited if required.
- References: IEEE Format
- Report Binding & Page Limit: Hard Bound (Golden Engraved Print on **BLUE** Binding) with minimum 40 pages. Hard Bound Report's side must be printed with "REPORT TITLE (2021-25)"

Title of the Report

(ES-456: Internship Report)

submitted in partial fulfillment of the requirement for the award of the degree of

Bachelor of Technology in Electronics and Communication Engineering

Submitted by

NAME OF THE STUDENT ENROLLMENT NO

Under the supervision of

NAME OF THE FACULTY SUPERVISOR DESIGNATION



Maharaja Agrasen Institute of Technology Sector-22, Rohini, Delhi-110086.

May/June 2025

DECLARATION

This is to certify that the material embodied in this Internship Report titled "......" being submitted in the partial fulfillment of the requirements for the award of the degree of Bachelor of Technology in Electronics and Communication Engineering is based on my original work. It is further certified that this Internship work has not been submitted in full or in part to this university or any other university for the award of any other degree or diploma. My indebtedness to other works has been duly acknowledged at the relevant places.

(Name of the Student)

Enrollment No

CERTIFICATE FROM THE COMPANY

This is to	certify that	t NAME C	F THE	E STUDENT	Γ (E ₁	nrollm	ent No) has
undertaken	internship	at NAME	AND	ADDRESS	OF	THE	ORGANIZATION	from
	to	under	the supe	ervision and g	guida	nce of	Mr./Ms	,
Designation	ı <mark>.</mark>							

(Name & Signature of the Authorized Signatory)

Designation

Name of the Company

Seal of the Company

CERTIFICATE FROM THE INSIITUTE

This is to	certify that	the work	embodied	in	this	Internsh	ip Rep	ort	titled
"			" being su	bmitt	ed in	the partia	ıl fulfillm	ent o	of the
requirements for	r the award	of the degree	ee of Bache	lor o	f Tec	hnology	in Electr	onics	s and
Communication	Engineering	, is original	and has be	en ca	arried	out by	NAME	OF	THE
STUDENT (Enr	ollment No)	under my su	pervi	sion a	nd guidan	ce.		
It is further cert	ified that this	s Internship w	ork has not	been	submi	tted in fu	ll or in p	art to	o this
university or any	other univer	sity for the aw	ard of any o	ther d	legree	or diplon	na to the	best o	of my
knowledge and b	elief.								
(Name of the Fa	culty Superv	visor)			(Name of	the TnP	Offic	er)
Designation							Desi	gnati	on

(Name of the HOD)

HOD

Name of the Institute

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Declaration

Certificate from the Company

Certificate from the Institute

Acknowledgement

Abstract

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- Chapter 1: Introduction of the Company
 - 1.1: About the Company
 - 1.2: Profile of the Company
- Chapter 2: Introduction of the Internship
 - 2.1: About the Internship
 - 2.2: Objectives of the Internship
 - 2.3: Roles and Responsibilities
- Chapter 3: Internship Activities
 - 3.1: Task Description
 - 3.2: Tools / Technologies / Platform used
 - 3.3: Technical Application
 - 3.4: Challenges Faced
- Chapter 4: Contribution to the Organization (How the student contributed to the organization during the internship. This can include solving problems, implementing ideas, or improving existing processes.)
- Chapter 5: Learning and Development
 - Describe the skills and knowledge gained during the internship, such as technical skills, teamwork, communication, problem-solving, etc.
 - Any certifications or additional training received during the internship period.
- Chapter 6: Summary and Conclusion
- Chapter 8: Suggestions for the Improvement

Bibliography

Appendix (if required)

LIST OF FIGURES

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